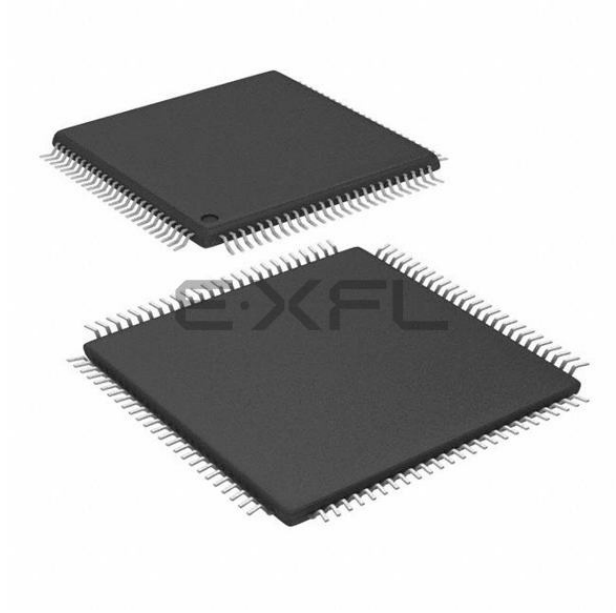
Microchip Technology - DSPIC33FJ64GS610T-I/PT Datasheet



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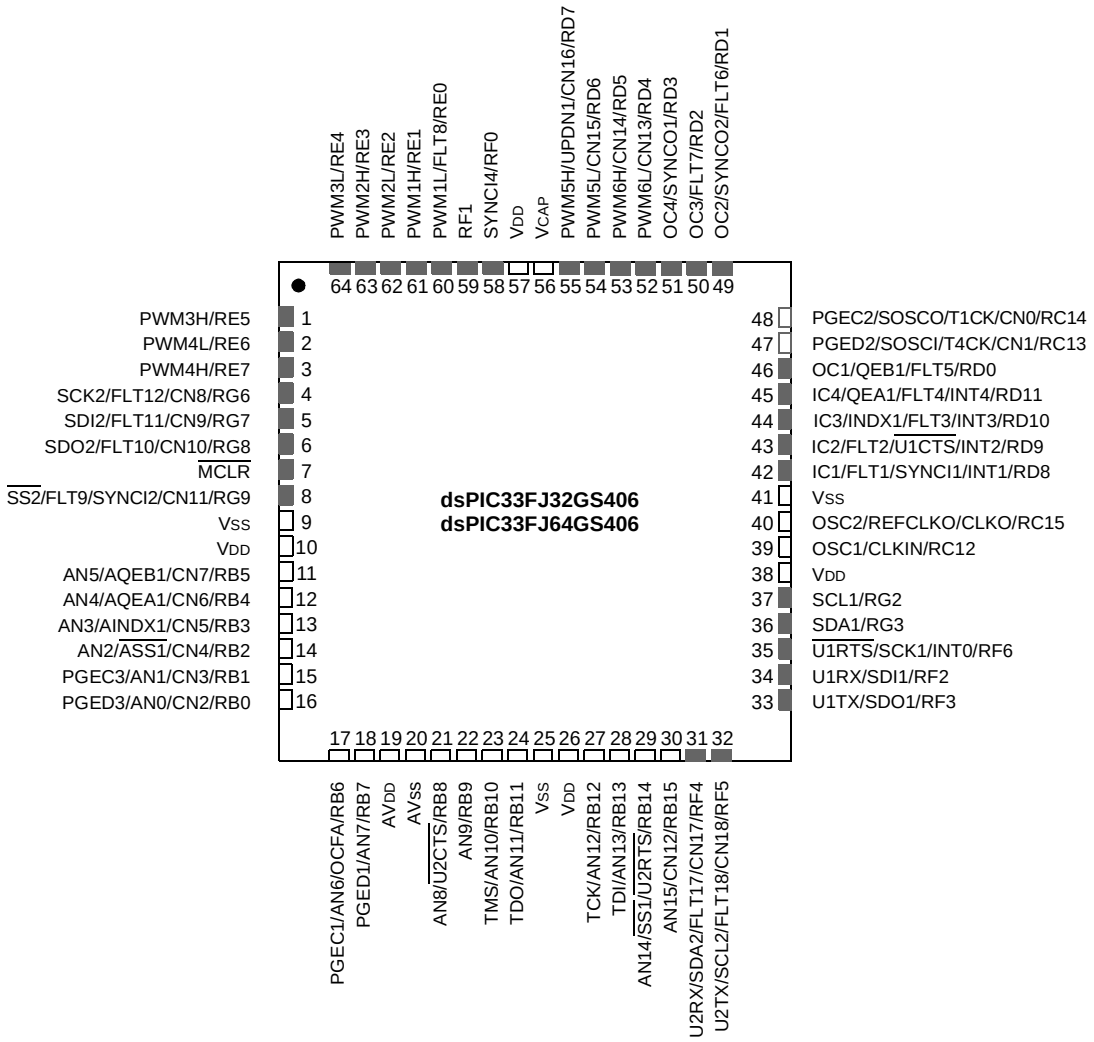
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	dsPIC
Core Size	16-Bit
Speed	40 MIPs
Connectivity	CANbus, I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, QEI, POR, PWM, WDT
Number of I/O	85
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	9K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 24x10b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj64gs610t-i-pt

Pin Diagrams (Continued)

64-Pin QFN

■ = Pins are up to 5V tolerant



Note: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

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FIGURE 2-11: AC-TO-DC POWER SUPPLY WITH PFC AND THREE OUTPUTS (12V, 5V AND 3.3V)

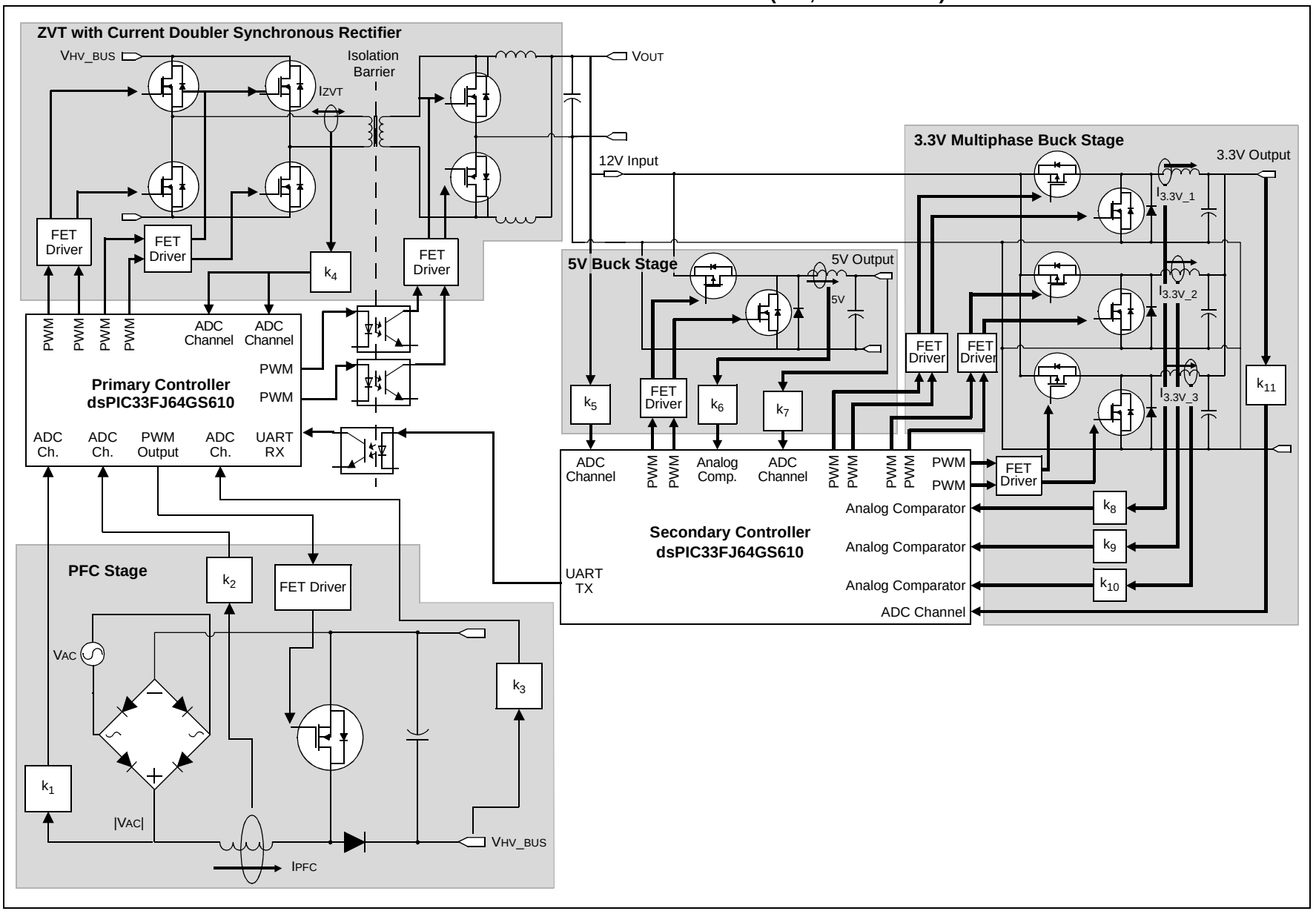


TABLE 4-4: INTERRUPT CONTROLLER REGISTER MAP FOR dsPIC33FJ64GS610 DEVICES (CONTINUED)

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
IPC14	00C0	—	—	—	—	—	QEI1IP2	QEI1IP1	QEI1IP0	—	PSEMIP2	PSEMIP1	PSEMIP0	—	—	—	—	0440
IPC16	00C4	—	—	—	—	—	U2EIP2	U2EIP1	U2EIP0	—	U1EIP2	U1EIP1	U1EIP0	—	—	—	—	0440
IPC17	00C6	—	—	—	—	—	C1TXIP2	C1TXIP1	C1TXIP0	—	—	—	—	—	—	—	—	0400
IPC18	00C8	—	QEI2IP2	QEI2IP1	QEI2IP0	—	—	—	—	—	PSESMIP2	PSESMIP1	PSESMIP0	—	—	—	—	4040
IPC20	00CC	—	ADCP10IP2	ADCP10IP1	ADCP10IP0	—	ADCP9IP2	ADCP9IP1	ADCP9IP0	—	ADCP8IP2	ADCP8IP1	ADCP8IP0	—	—	—	—	4440
IPC21	00CE	—	—	—	—	—	—	—	—	—	ADCP12IP2	ADCP12IP1	ADCP12IP0	—	ADCP11IP2	ADCP11IP1	ADCP11IP0	0044
IPC23	00D2	—	PWM2IP2	PWM2IP1	PWM2IP0	—	PWM1IP2	PWM1IP1	PWM1IP0	—	—	—	—	—	—	—	—	4400
IPC24	00D4	—	PWM6IP2	PWM6IP1	PWM6IP0	—	PWM5IP2	PWM5IP1	PWM5IP0	—	PWM4IP2	PWM4IP1	PWM4IP0	—	PWM3IP2	PWM3IP1	PWM3IP0	4444
IPC25	00D6	—	AC2IP2	AC2IP1	AC2IP0	—	PWM9IP2	PWM9IP1	PWM9IP0	—	PWM8IP2	PWM8IP1	PWM8IP0	—	PWM7IP2	PWM7IP1	PWM7IP0	4444
IPC26	00D8	—	—	—	—	—	—	—	—	—	AC4IP2	AC4IP1	AC4IP0	—	AC3IP2	AC3IP1	AC3IP0	0044
IPC27	00DA	—	ADCP1IP2	ADCP1IP1	ADCP1IP0	—	ADCP0IP2	ADCP0IP1	ADCP0IP0	—	—	—	—	—	—	—	—	4400
IPC28	00DC	—	ADCP5IP2	ADCP5IP1	ADCP5IP0	—	ADCP4IP2	ADCP4IP1	ADCP4IP0	—	ADCP3IP2	ADCP3IP1	ADCP3IP0	—	ADCP2IP2	ADCP2IP1	ADCP2IP0	4444
IPC29	00DE	—	—	—	—	—	—	—	—	—	ADCP7IP2	ADCP7IP1	ADCP7IP0	—	ADCP6IP2	ADCP6IP1	ADCP6IP0	0044
INTTREG	00E0	—	—	—	—	ILR3	ILR2	ILR1	ILR0	—	VECNUM6	VECNUM5	VECNUM4	VECNUM3	VECNUM2	VECNUM1	VECNUM0	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-18: HIGH-SPEED PWM GENERATOR 2 REGISTER MAP

File Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PWMCON2	0440	FLTSTAT	CLSTAT	TRGSTAT	FLTIEN	CLIEN	TRGIEN	ITB	MDCS	DTC1	DTC0	DTCP	—	MTBS	CAM	XPRES	IUE	0000
IOCON2	0442	PENH	PENL	POLH	POLL	PMOD1	PMOD0	OVRENH	OVRENL	OVRDAT1	OVRDAT0	FLTDAT1	FLTDAT0	CLDAT1	CLDAT0	SWAP	OSYNC	0000
FCLCON2	0444	IFLTMOD	CLSRC4	CLSRC3	CLSRC2	CLSRC1	CLSRC0	CLPOL	CLMOD	FLTSRC4	FLTSRC3	FLTSRC2	FLTSRC1	FLTSRC0	FLTPOL	FLTMOD1	FLTMOD0	0000
PDC2	0446	PDC2<15:0>																0000
PHASE2	0448	PHASE2<15:0>																0000
DTR2	044A	—	—	DTR2<13:0>														0000
ALTDTR2	044C	—	—	ALTDTR2<13:0>														0000
SDC2	044E	SDC2<15:0>																0000
SPHASE2	0450	SPHASE2<15:0>																0000
TRIG2	0452	TRGCMP<12:0>													—	—	—	0000
TRGCON2	0454	TRGDIV3	TRGDIV2	TRGDIV1	TRGDIV0	—	—	—	—	DTM	—	TRGSTRT5	TRGSTRT4	TRGSTRT3	TRGSTRT2	TRGSTRT1	TRGSTRT0	0000
STRIG2	0456	STRGCMP<12:0>													—	—	—	0000
PWMCAP2	0458	PWMCAP<12:0>													—	—	—	0000
LEBCON2	045A	PHR	PHF	PLR	PLF	FLTLEBEN	CLLEBEN	—	—	—	—	BCH	BCL	BPHH	BPHL	BPLH	BPLL	0000
LEBDLY2	045C	—	—	—	—	LEB<8:0>									—	—	—	0000
AUXCON2	045E	HRPDIS	HRDDIS	—	—	BLANKSEL3	BLANKSEL2	BLANKSEL1	BLANKSEL0	—	—	CHOPSEL3	CHOPSEL2	CHOPSEL1	CHOPSEL0	CHOPHEN	CHOPLEN	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

REGISTER 7-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
NSTDIS	OVAERR	OVBERR	COVAERR	COVBERR	OVATE	OVBTE	COVTE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
SFTACERR	DIV0ERR	DMACERR	MATHERR	ADDRERR	STKERR	OSCFAIL	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **NSTDIS:** Interrupt Nesting Disable bit
1 = Interrupt nesting is disabled
0 = Interrupt nesting is enabled

bit 14 **OVAERR:** Accumulator A Overflow Trap Flag bit
1 = Trap was caused by an overflow of Accumulator A
0 = Trap was not caused by an overflow of Accumulator A

bit 13 **OVBERR:** Accumulator B Overflow Trap Flag bit
1 = Trap was caused by an overflow of Accumulator B
0 = Trap was not caused by an overflow of Accumulator B

bit 12 **COVAERR:** Accumulator A Catastrophic Overflow Trap Flag bit
1 = Trap was caused by a catastrophic overflow of Accumulator A
0 = Trap was not caused by a catastrophic overflow of Accumulator A

bit 11 **COVBERR:** Accumulator B Catastrophic Overflow Trap Flag bit
1 = Trap was caused by a catastrophic overflow of Accumulator B
0 = Trap was not caused by a catastrophic overflow of Accumulator B

bit 10 **OVATE:** Accumulator A Overflow Trap Enable bit
1 = Trap overflow of Accumulator A
0 = Trap is disabled

bit 9 **OVBTE:** Accumulator B Overflow Trap Enable bit
1 = Trap overflow of Accumulator B
0 = Trap is disabled

bit 8 **COVTE:** Catastrophic Overflow Trap Enable bit
1 = Trap on a catastrophic overflow of Accumulator A or B is enabled
0 = Trap is disabled

bit 7 **SFTACERR:** Shift Accumulator Error Status bit
1 = Math error trap was caused by an invalid accumulator shift
0 = Math error trap was not caused by an invalid accumulator shift

bit 6 **DIV0ERR:** Arithmetic Error Status bit
1 = Math error trap was caused by a divide-by-zero
0 = Math error trap was not caused by a divide-by-zero

bit 5 **DMACERR:** DMA Controller Error Status bit
1 = DMA Controller error trap has occurred
0 = DMA Controller error trap has not occurred

bit 4 **MATHERR:** Arithmetic Error Status bit
1 = Math error trap has occurred
0 = Math error trap has not occurred

REGISTER 16-23: LEBCONx: LEADING-EDGE BLANKING CONTROL x REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
PHR	PHF	PLR	PLF	FLTLEBEN	CLLEBEN	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	BCH(1)	BCL(1)	BPHH	BPHL	BPLH	BPLL
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **PHR:** PWMxH Rising Edge Trigger Enable bit
1 = Rising edge of PWMxH will trigger Leading-Edge Blanking counter
0 = Leading-Edge Blanking ignores rising edge of PWMxH

bit 14 **PHF:** PWMxH Falling Edge Trigger Enable bit
1 = Falling edge of PWMxH will trigger Leading-Edge Blanking counter
0 = Leading-Edge Blanking ignores falling edge of PWMxH

bit 13 **PLR:** PWMxL Rising Edge Trigger Enable bit
1 = Rising edge of PWMxL will trigger Leading-Edge Blanking counter
0 = Leading-Edge Blanking ignores rising edge of PWMxL

bit 12 **PLF:** PWMxL Falling Edge Trigger Enable bit
1 = Falling edge of PWMxL will trigger Leading-Edge Blanking counter
0 = Leading-Edge Blanking ignores falling edge of PWMxL

bit 11 **FLTLEBEN:** Fault Input Leading-Edge Blanking Enable bit
1 = Leading-Edge Blanking is applied to selected Fault input
0 = Leading-Edge Blanking is not applied to selected Fault input

bit 10 **CLLEBEN:** Current-Limit Leading-Edge Blanking Enable bit
1 = Leading-Edge Blanking is applied to selected current-limit input
0 = Leading-Edge Blanking is not applied to selected current-limit input

bit 9-6 **Unimplemented:** Read as '0'

bit 5 **BCH:** Blanking in Selected Blanking Signal High Enable bit(1)
1 = State blanking (of current-limit and/or Fault input signals) when selected blanking signal is high
0 = No blanking when selected blanking signal is high

bit 4 **BCL:** Blanking in Selected Blanking Signal Low Enable bit(1)
1 = State blanking (of current-limit and/or Fault input signals) when selected blanking signal is low
0 = No blanking when selected blanking signal is low

bit 3 **BPHH:** Blanking in PWMxH High Enable bit
1 = State blanking (of current-limit and/or Fault input signals) when PWMxH output is high
0 = No blanking when PWMxH output is high

bit 2 **BPHL:** Blanking in PWMxH Low Enable bit
1 = State blanking (of current-limit and/or Fault input signals) when PWMxH output is low
0 = No blanking when PWMxH output is low

Note 1: The blanking signal is selected via the BLANKSELx bits in the AUXCONx register.

REGISTER 16-26: PWMCAPx: PRIMARY PWM TIME BASE CAPTURE x REGISTER

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
PWMCAP<12:5>(1,2,3,4)							
bit 15							bit 8

R-0	R-0	R-0	R-0	R-0	U-0	U-0	U-0
PWMCAP<4:0>(1,2,3,4)					—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-3 **PWMCAP<12:0>:** Captured PWM Time Base Value bits(1,2,3,4)
The value in this register represents the captured PWM time base value when a leading edge is detected on the current-limit input.

bit 2-0 **Unimplemented:** Read as '0'

Note 1: The capture feature is only available on the primary output (PWMxH).
2: This feature is active only after LEB processing on the current-limit input signal is complete.
3: The minimum capture resolution is 8.32 ns.
4: This feature can be used when the XPRES bit (PWMCONx<1>) is set to '0'.

21.0 ENHANCED CAN (ECAN™) MODULE

Note 1: This data sheet summarizes the features of the dsPIC33FJ32GS406/606/608/610 and dsPIC33FJ64GS406/606/608/610 families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"ECAN™"** (DS70185) in the *dsPIC33/PIC24 Family Reference Manual*, which is available from the Microchip web site (www.microchip.com). The information in this data sheet supersedes the information in the FRM.

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 "Memory Organization"** in this data sheet for device-specific register and bit information.

21.1 Overview

The Enhanced Controller Area Network (ECAN™) module is a serial interface, useful for communicating with other ECAN modules or microcontroller devices. This interface/protocol was designed to allow communications within noisy environments. The dsPIC33FJ64GS606/608/610 devices contain one ECAN module.

The ECAN module is a communication controller implementing the CAN 2.0 A/B protocol, as defined in the BOSCH CAN specification. The module supports CAN 1.2, CAN 2.0A, CAN 2.0B Passive and CAN 2.0B Active versions of the protocol. The module implementation is a full CAN system. The CAN specification is not covered within this data sheet. The reader can refer to the BOSCH CAN specification for further details.

The module features are as follows:

- Implementation of the CAN Protocol, CAN 1.2, CAN 2.0A and CAN 2.0B
- Standard and Extended Data Frames
- 0-8 Bytes Data Length
- Programmable Bit Rate, up to 1 Mbit/sec
- Automatic Response to Remote Transmission Requests
- Up to 8 Transmit Buffers with Application-Specified Prioritization and Abort Capability (each buffer can contain up to 8 bytes of data)
- Up to 32 Receive Buffers (each buffer can contain up to 8 bytes of data)
- Up to 16 Full (Standard/Extended Identifier) Acceptance Filters
- Three Full Acceptance Filter Masks
- DeviceNet™ Addressing Support
- Programmable Wake-up Functionality with Integrated Low-Pass Filter
- Programmable Loopback mode Supports Self-Test Operation
- Signaling via Interrupt Capabilities for all CAN Receiver and Transmitter Error States
- Programmable Clock Source
- Programmable Link to Input Capture module (IC2 for CAN1) for Time-Stamping and Network Synchronization
- Low-Power Sleep and Idle mode

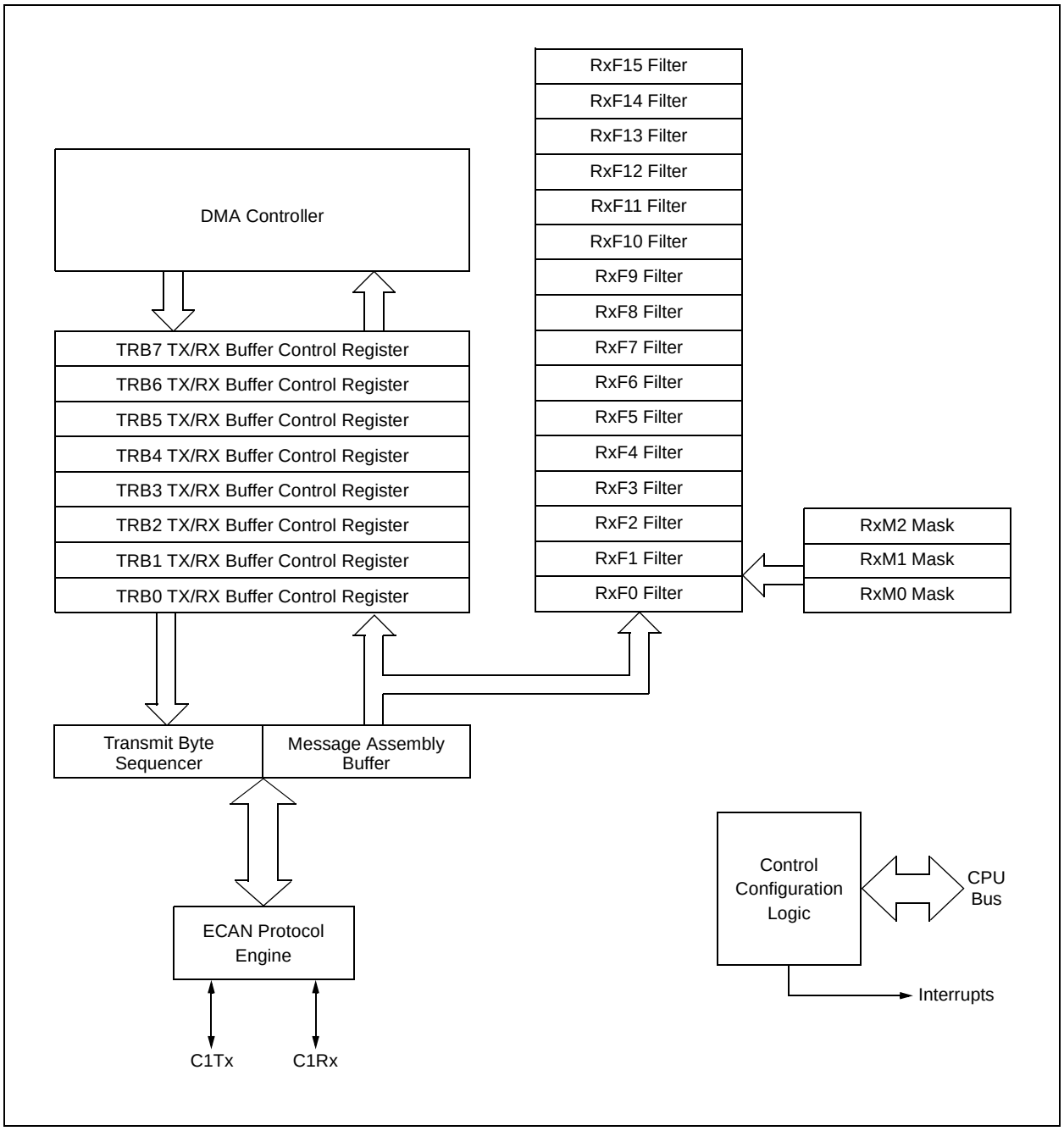
The CAN bus module consists of a protocol engine and message buffering/control. The CAN protocol engine handles all functions for receiving and transmitting messages on the CAN bus. Messages are transmitted by first loading the appropriate data registers. Status and errors can be checked by reading the appropriate registers. Any message detected on the CAN bus is checked for errors and then matched against filters to see if it should be received and stored in one of the receive registers.

21.2 Frame Types

The CAN module transmits various types of frames which include data messages, or remote transmission requests initiated by the user, as other frames that are automatically generated for control purposes. The following frame types are supported:

- Standard Data Frame: A standard data frame is generated by a node when the node wishes to transmit data. It includes an 11-bit Standard Identifier (SID), but not an 18-bit Extended Identifier (EID).
- Extended Data Frame: An extended data frame is similar to a standard data frame, but includes an Extended Identifier as well.
- Remote Frame: It is possible for a destination node to request the data from the source. For this purpose, the destination node sends a remote frame with an identifier that matches the identifier of the required data frame. The appropriate data source node sends a data frame as a response to this remote request.
- Error Frame: An error frame is generated by any node that detects a bus error. An error frame consists of two fields: an error flag field and an error delimiter field.
- Overload Frame: An overload frame can be generated by a node as a result of two conditions. First, the node detects a dominant bit during interframe space which is an illegal condition. Second, due to internal conditions, the node is not yet able to start reception of the next message. A node can generate a maximum of 2 sequential overload frames to delay the start of the next message.
- Interframe Space: Interframe space separates a proceeding frame (of whatever type) from a following data or remote frame.

FIGURE 21-1: ECANx MODULE BLOCK DIAGRAM



REGISTER 21-14: CxBUFPNT3: ECANx FILTER 8-11 BUFFER POINTER REGISTER 3

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F11BP3	F11BP2	F11BP1	F11BP0	F10BP3	F10BP2	F10BP1	F10BP0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F9BP3	F9BP2	F9BP1	F9BP0	F8BP3	F8BP2	F8BP1	F8BP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-12 **F11BP<3:0>:** RX Buffer Mask for Filter 11 bits
1111 = Filter hits received in RX FIFO buffer
1110 = Filter hits received in RX Buffer 14
•
•
•
0001 = Filter hits received in RX Buffer 1
0000 = Filter hits received in RX Buffer 0

bit 11-8 **F10BP<3:0>:** RX Buffer Mask for Filter 10 bits (same values as bits<15:12>)

bit 7-4 **F9BP<3:0>:** RX Buffer Mask for Filter 9 bits (same values as bits<15:12>)

bit 3-0 **F8BP<3:0>:** RX Buffer Mask for Filter 8 bits (same values as bits<15:12>)

REGISTER 21-15: CxBUFPNT4: ECANx FILTER 12-15 BUFFER POINTER REGISTER 4

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F15BP3	F15BP2	F15BP1	F15BP0	F14BP3	F14BP2	F14BP1	F14BP0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
F13BP3	F13BP2	F13BP1	F13BP0	F12BP3	F12BP2	F12BP1	F12BP0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-12 **F15BP<3:0>:** RX Buffer Mask for Filter 15 bits
1111 = Filter hits received in RX FIFO buffer
1110 = Filter hits received in RX Buffer 14
•
•
•
0001 = Filter hits received in RX Buffer 1
0000 = Filter hits received in RX Buffer 0

bit 11-8 **F14BP<3:0>:** RX Buffer Mask for Filter 14 bits (same values as bits<15:12>)

bit 7-4 **F13BP<3:0>:** RX Buffer Mask for Filter 13 bits (same values as bits<15:12>)

bit 3-0 **F12BP<3:0>:** RX Buffer Mask for Filter 12 bits (same values as bits<15:12>)

21.4 ECANx Message Buffers

ECANx message buffers are part of DMA RAM memory. They are not ECAN Special Function Registers. The user application must directly write into the DMA RAM area that is configured for ECANx message buffers. The location and size of the buffer area is defined by the user application.

BUFFER 21-1: ECANx MESSAGE BUFFER WORD 0

U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	SID10	SID9	SID8	SID7	SID6
bit 15							bit 8

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
SID5	SID4	SID3	SID2	SID1	SID0	SRR	IDE
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as ‘0’

bit 12-2 **SID<10:0>:** Standard Identifier bits

bit 1 **SRR:** Substitute Remote Request bit
1 = Message will request remote transmission
0 = Normal message

bit 0 **IDE:** Extended Identifier bit
1 = Message will transmit the Extended Identifier
0 = Message will transmit the Standard Identifier

BUFFER 21-2: ECANx MESSAGE BUFFER WORD 1

U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x
—	—	—	—	EID<17:14>			
bit 15							bit 8

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
EID<13:6>							
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-12 **Unimplemented:** Read as ‘0’

bit 11-0 **EID<17:6>:** Extended Identifier bits

REGISTER 22-8: ADCPC2: ADC CONVERT PAIR CONTROL REGISTER 2 (CONTINUED)

bit 12-8 **TRGSRC5<4:0>:** Trigger 5 Source Selection bits

Selects trigger source for conversion of Analog Channels AN11 and AN10.
11111 = Timer2 period match
11110 = PWM Generator 8 current-limit ADC trigger
11101 = PWM Generator 7 current-limit ADC trigger
11100 = PWM Generator 6 current-limit ADC trigger
11011 = PWM Generator 5 current-limit ADC trigger
11010 = PWM Generator 4 current-limit ADC trigger
11001 = PWM Generator 3 current-limit ADC trigger
11000 = PWM Generator 2 current-limit ADC trigger
10111 = PWM Generator 1 current-limit ADC trigger
10110 = PWM Generator 9 secondary trigger selected
10101 = PWM Generator 8 secondary trigger selected
10100 = PWM Generator 7 secondary trigger selected
10011 = PWM Generator 6 secondary trigger selected
10010 = PWM Generator 5 secondary trigger selected
10001 = PWM Generator 4 secondary trigger selected
10000 = PWM Generator 3 secondary trigger selected
01111 = PWM Generator 2 secondary trigger selected
01110 = PWM Generator 1 secondary trigger selected
01101 = PWM secondary Special Event Trigger selected
01100 = Timer1 period match
01011 = PWM Generator 8 primary trigger selected
01010 = PWM Generator 7 primary trigger selected
01001 = PWM Generator 6 primary trigger selected
01000 = PWM Generator 5 primary trigger selected
00111 = PWM Generator 4 primary trigger selected
00110 = PWM Generator 3 primary trigger selected
00101 = PWM Generator 2 primary trigger selected
00100 = PWM Generator 1 primary trigger selected
00011 = PWM Special Event Trigger selected
00010 = Global software trigger selected
00001 = Individual software trigger selected
00000 = No conversion is enabled

bit 7 **IRQEN4:** Interrupt Request Enable 4 bit

1 = Enables IRQ generation when requested conversion of Channels AN9 and AN8 is completed
0 = IRQ is not generated

bit 6 **PEND4:** Pending Conversion Status 4 bit

1 = Conversion of Channels AN9 and AN8 is pending; set when selected trigger is asserted
0 = Conversion is complete

bit 5 **SWTRG4:** Software Trigger 4 bit

1 = Starts conversion of AN9 and AN8 (if selected by the TRGSRCx<4:0> bits)**(1)**
This bit is automatically cleared by hardware when the PEND4 bit is set.
0 = Conversion has not started

Note 1: The trigger source must be set as an individual software trigger prior to setting this bit to '1'. If other conversions are in progress, the conversion is performed when the conversion resources are available.

23.3 Module Applications

This module provides a means for the SMPS dsPIC® DSC devices to monitor voltage and currents in a power conversion application. The ability to detect transient conditions and stimulate the dsPIC DSC processor and/or peripherals, without requiring the processor and ADC to constantly monitor voltages or currents, frees the dsPIC DSC to perform other tasks.

The comparator module has a high-speed comparator and an associated 10-bit DAC that provides a programmable reference voltage to the inverting input of the comparator. The polarity of the comparator output is user-programmable. The output of the module can be used in the following modes:

- Generate an Interrupt
- Trigger an ADC Sample-and-Convert Process
- Truncate the PWM Signal (current limit)
- Truncate the PWM Period (current minimum)
- Disable the PWM Outputs (Fault latch)

The output of the comparator module may be used in multiple modes at the same time, such as: 1) generate an interrupt, 2) have the ADC take a sample and convert it, and 3) truncate the PWM output in response to a voltage being detected beyond its expected value.

The comparator module can also be used to wake-up the system from Sleep or Idle mode when the analog input voltage exceeds the programmed threshold voltage.

23.4 DAC

The range of the DAC is controlled via an analog multiplexer that selects either AVDD/2, an internal reference source, INTREF, or an external reference source, EXTREF. The full range of the DAC (AVDD/2) will typically be used when the chosen input source pin is shared with the ADC. The reduced range option (INTREF) will likely be used when monitoring current levels using a current sense resistor. Usually, the measured voltages in such applications are small (<1.25V); therefore the option of using a reduced reference range for the comparator extends the available DAC resolution in these applications. The use of an external reference enables the user to connect to a reference that better suits their application.

DACOUT, shown in Figure 23-1, can only be associated with a single comparator at a given time.

Note:	It should be ensured in software that multiple DACOE bits are not set. The output on the DACOUT pin will be indeterminate if multiple comparators enable the DAC output.

23.5 Interaction with I/O Buffers

If the comparator module is enabled and a pin has been selected as the source for the comparator, then the chosen I/O pad must disable the digital input buffer associated with the pad to prevent excessive currents in the digital buffer due to analog input voltages.

23.6 Digital Logic

The CMPCONx register (see Register 23-1) provides the control logic that configures the comparator module. The digital logic provides a glitch filter for the comparator output to mask transient signals in less than two instruction cycles. In Sleep or Idle mode, the glitch filter is bypassed to enable an asynchronous path from the comparator to the interrupt controller. This asynchronous path can be used to wake-up the processor from Sleep or Idle mode.

The comparator can be disabled while in Idle mode if the CMPSIDL bit is set. If a device has multiple comparators, if any CMPSIDL bit is set, then the entire group of comparators will be disabled while in Idle mode. This behavior reduces complexity in the design of the clock control logic for this module.

The digital logic also provides a one TCY width pulse generator for triggering the ADC and generating interrupt requests.

The CMPDACx (see Register 23-2) register provides the digital input value to the reference DAC.

If the module is disabled, the DAC and comparator are disabled to reduce power consumption.

23.7 Comparator Input Range

The comparator has a limitation for the input Common-Mode Range (CMR) of (AVDD – 1.5V), typical. This means that both inputs should not exceed this range. As long as one of the inputs is within the Common-Mode Range, the comparator output will be correct. However, any input exceeding the CMR limitation will cause the comparator input to be saturated.

If both inputs exceed the CMR, the comparator output will be indeterminate.

23.8 DAC Output Range

The DAC has a limitation for the maximum reference voltage input of (AVDD – 1.6) volts. An external reference voltage input should not exceed this value or the reference DAC output will become indeterminate.

23.9 Comparator Registers

The comparator module is controlled by the following registers:

- CMPCONx: Comparator Control x Register
- CMPDACx: Comparator DAC Control x Register

TABLE 25-1: SYMBOLS USED IN OPCODE DESCRIPTIONS (CONTINUED)

Field	Description
Wm*Wm	Multiplicand and Multiplier Working register pair for Square instructions ∈ {W4 * W4,W5 * W5,W6 * W6,W7 * W7}
Wm*Wn	Multiplicand and Multiplier Working register pair for DSP instructions ∈ {W4 * W5,W4 * W6,W4 * W7,W5 * W6,W5 * W7,W6 * W7}
Wn	One of 16 Working registers ∈ {W0..W15}
Wnd	One of 16 Destination Working registers ∈ {W0...W15}
Wns	One of 16 Source Working registers ∈ {W0...W15}
WREG	W0 (Working register used in file register instructions)
Ws	Source W register ∈ { Ws, [Ws], [Ws++], [Ws--], [++Ws], [--Ws] }
Wso	Source W register ∈ { Wns, [Wns], [Wns++], [Wns--], [++Wns], [--Wns], [Wns+Wb] }
Wx	X Data Space Prefetch Address register for DSP instructions ∈ {[W8] + = 6, [W8] + = 4, [W8] + = 2, [W8], [W8] - = 6, [W8] - = 4, [W8] - = 2, [W9] + = 6, [W9] + = 4, [W9] + = 2, [W9], [W9] - = 6, [W9] - = 4, [W9] - = 2, [W9 + W12], none}
Wxd	X Data Space Prefetch Destination register for DSP instructions ∈ {W4...W7}
Wy	Y Data Space Prefetch Address register for DSP instructions ∈ {[W10] + = 6, [W10] + = 4, [W10] + = 2, [W10], [W10] - = 6, [W10] - = 4, [W10] - = 2, [W11] + = 6, [W11] + = 4, [W11] + = 2, [W11], [W11] - = 6, [W11] - = 4, [W11] - = 2, [W11 + W12], none}
Wyd	Y Data Space Prefetch Destination register for DSP instructions ∈ {W4...W7}

TABLE 27-34: SPIx SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min**	**Typ(2)**	**Max**	**Units**	**Conditions**
SP70	TscP	Maximum SCKx Input Frequency	—	—	15	MHz	See **Note 3**
SP72	TscF	SCKx Input Fall Time	—	—	—	ns	See Parameter DO32 and **Note 4**
SP73	TscR	SCKx Input Rise Time	—	—	—	ns	See Parameter DO31 and **Note 4**
SP30	TdoF	SDOx Data Output Fall Time	—	—	—	ns	See Parameter DO32 and **Note 4**
SP31	TdoR	SDOx Data Output Rise Time	—	—	—	ns	See Parameter DO31 and **Note 4**
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	30	—	—	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	—	—	ns	
SP50	TssL2scH, TssL2scL	$\overline{SSx}$ ↓ to SCKx ↑ or SCKx Input	120	—	—	ns	
SP51	TssH2doZ	$\overline{SSx}$ ↑ to SDOx Output High-Impedance	10	—	50	ns	See **Note 4**
SP52	TscH2ssH TscL2ssH	$\overline{SSx}$ after SCKx Edge	1.5 TCY + 40	—	—	ns	See **Note 4**
SP60	TssL2doV	$\overline{SDOx}$ Data Output Valid after $\overline{SSx}$ Edge	—	—	50	ns	

Note 1: These parameters are characterized, but are not tested in manufacturing.

2: Data in “Typ” column is at 3.3V, +25°C unless otherwise stated.

3: The minimum clock period for SCKx is 66.7 ns. Therefore, the SCKx clock, generated by the master, must not violate this specification.

4: Assumes 50 pF load on all SPIx pins.

TABLE 27-38: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Param No.	**Symbol**	**Characteristic**		**Min(1)**	**Max**	**Units**	**Conditions**
IM10	TLO:SCL	Clock Low Time	100 kHz mode	TCY/2 (BRG + 1)	—	µs	
			400 kHz mode	TCY/2 (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY/2 (BRG + 1)	—	µs	
IM11	THI:SCL	Clock High Time	100 kHz mode	TCY/2 (BRG + 1)	—	µs	
			400 kHz mode	TCY/2 (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY/2 (BRG + 1)	—	µs	
IM20	TF:SCL	SDAx and SCLx Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(2)	—	100	ns	
IM21	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(2)	—	300	ns	
IM25	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	
			400 kHz mode	100	—	ns	
			1 MHz mode(2)	40	—	ns	
IM26	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	µs	
			400 kHz mode	0	0.9	µs	
			1 MHz mode(2)	0.2	—	µs	
IM30	TSU:STA	Start Condition Setup Time	100 kHz mode	TCY/2 (BRG + 1)	—	µs	Only relevant for Repeated Start condition
			400 kHz mode	TCY/2 (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY/2 (BRG + 1)	—	µs	
IM31	THD:STA	Start Condition Hold Time	100 kHz mode	TCY/2 (BRG + 1)	—	µs	After this period, the first clock pulse is generated
			400 kHz mode	TCY/2 (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY/2 (BRG + 1)	—	µs	
IM33	TSU:STO	Stop Condition Setup Time	100 kHz mode	TCY/2 (BRG + 1)	—	µs	
			400 kHz mode	TCY/2 (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY/2 (BRG + 1)	—	µs	
IM34	THD:STO	Stop Condition Hold Time	100 kHz mode	TCY/2 (BRG + 1)	—	ns	
			400 kHz mode	TCY/2 (BRG + 1)	—	ns	
			1 MHz mode(2)	TCY/2 (BRG + 1)	—	ns	
IM40	TAA:SCL	Output Valid from Clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode(2)	—	400	ns	
IM45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	—	µs	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	µs	
			1 MHz mode(2)	0.5	—	µs	
IM50	CB	Bus Capacitive Loading		—	400	pF	
IM51	TPGD	Pulse Gobbler Delay		65	390	ns	See **Note 3**

Note 1: BRG is the value of the I^2C™ Baud Rate Generator. Refer to **"Inter-Integrated Circuit™ (I^2C™)"** (DS70000195) in the "*dsPIC33/PIC24 Family Reference Manual*".

2: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

3: Typical value for this parameter is 130 ns.

FIGURE 27-21: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)

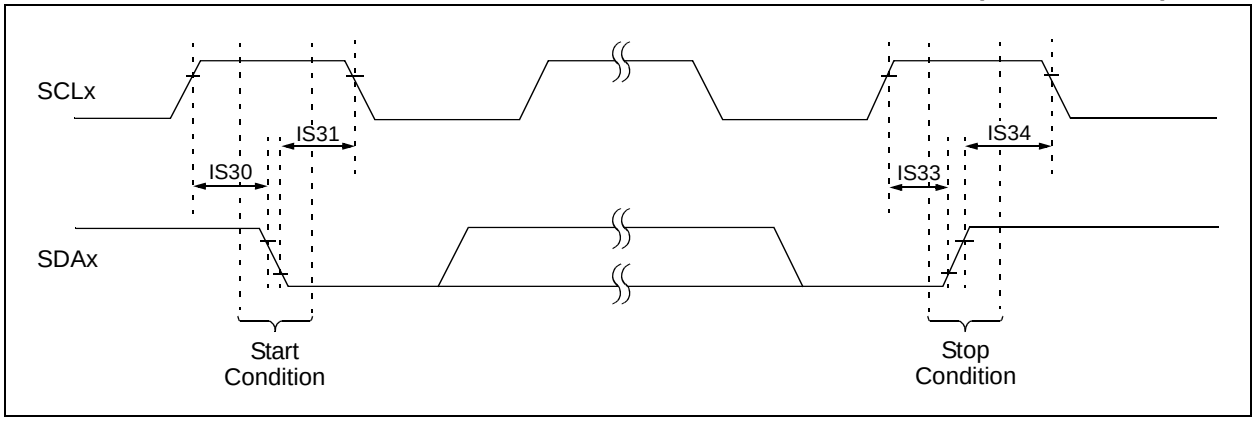
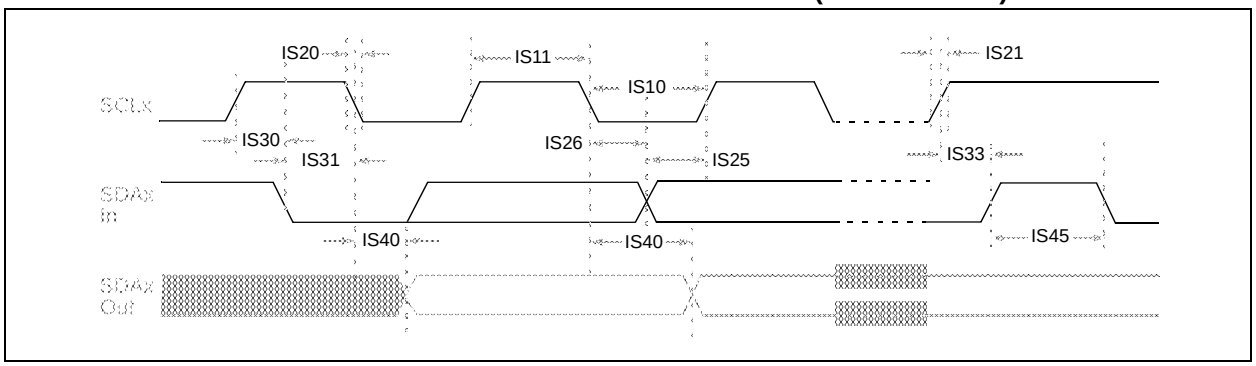


FIGURE 27-22: I2Cx BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)



Revision C (February 2010)

This revision includes minor typographical and formatting changes throughout the data sheet text.

All other changes are referenced by their respective section in Table B-2.

TABLE B-2: MAJOR SECTION UPDATES

Section Name	Update Description
Section 16.0 “High-Speed PWM”	Added Note 2 to PTPER (Register 16-3). Added Note 1 to SEVTCMP (Register 16-4). Updated Note 1 in MDC (Register 16-10). Updated Note 5 and added Note 6 to PWMCONx (Register 16-11). Updated Note 1 in PDCx (Register 16-12). Updated Note 1 in SDCx (Register 16-13). Updated Note 1 and Note 2 in PHASEx (Register 16-14). Updated Note 2 in SPHASEx (Register 16-15). Updated Note 1 in FCLCONx (Register 16-21). Added Note 1 to STRIGx (Register 16-22). Updated Leading-Edge Blanking Delay increment value from 8.4 ns to 8.32 ns and added a shaded note in LEBDLYx (Register 16-24). Added Note 3 and Note 4 to PWMCAPx (Register 16-26).
Section 27.0 “Electrical Characteristics”	Updated the Min and Typ values for the Internal Voltage Regulator specifications in Table 27-13. Updated the Min and Max values for the Internal RC Accuracy specifications in Table 27-20.